

Montana Microfabrication Facility

Ångstrom Engineering – Sputter System

System Overview

This physical vapor deposition sputter tool is a research grade instrument with three targets, two RF power supplies, one DC power supply, substrate heating, and multiple process gases.

Safety

- This tool contains high voltage sources. Do not go behind the tool, attempt to open covers, or work inside the tool.
- Avoid pinching your fingers in the load lock door.
- Use caution to avoid bumping your head when the door is open or on the transfer arm.
- After long depositions, the sample stage may be very hot. Use caution.
- If the tool is on fire or if someone is in immediate danger, hit the emergency stop on the front of the tool.

Allowed Materials and Processes

• Target link: (in progress)

Restricted Materials and Processes

• Do not attempt to make your own recipes without extensive training and permission from the lab manager.

Operating Procedures

- 1. Check tool status and configuration
 - a. Visit http://www.mmf.montana.edu/equipment-status.html.
 - b. Request different targets, shields, or gases as far in advance as possible, preferably at least two weeks, by emailing the lab manager and <u>mmfstaff@montana.edu</u>.
- 2. Check tool reservations for conflicts and reserve the tool
- 3. Check lab status
 - a. Turn on N_2 for the lab and check the house N_2 bottle pressure. If it is below 300 PSI, report the shortage to staff.
 - b. Check process gas bottle pressures (Ar,, O₂, N₂). If any are below 300 PSI, report the shortage to staff.
 - c. Check that the correct process gas is selected for your process. O_2 and N_2 can be switched; request a change with staff if necessary. Do not attempt this process without explicit training from the staff and accompanying documentation. It is very easy to contaminate the gas lines.
- 4. Log into SUMS
- 5. Equipment checks



- a. Check deposition chamber pressure. The ion gauge should read <5e-7 Torr if left overnight or <1e-6 Torr if recently used. The convectron and baratron gauges should read "Off Scale".
- b. Check that the cryo temperature is below 14 K. If the temperature is <18 K, use the tool but report the problem to the lab manager. If the temperature is >18 K, do not use the tool.
- c. Check load lock pressure
 - i. Convectron should read "Off Scale".
 - ii. Note: there is no ion gauge connected to the load lock, so this reading is meaningless and can be ignored.
- d. Double check the target configuration by selecting "BASE FLANGE DETAIL".
- e. Check mass flow control settings
 - i. Check which gases are currently connected to the tool. Ar is always connected, but N_2 or O_2 can be selected. Check the valve on the wall behind the tool under the pressure gauges on the inside of the wall.
 - ii. Check the MKS 4 Channel Readout. Any channel set to "Rem" will turn on during a process. Ar is connected to channel 1, and either N₂ or O₂ is connected to channel 3. For most processes, only Ar is used, so the other channels should all be in the "Off" position.
- f. Check pressure control settings
 - i. The VAT Adaptive Pressure Controller should have the "Remote" and "Open" LEDs on. If "Local" is lit, press and hold "Remote" until that LED turns on. You may need to reset a fault on the Angstrom software.
- g. Check power supplies
 - i. Check that the required power supplies are on. The RF supplies should be on and should read "Remote OFF" in the upper right corner. They should also read "auto" under the diagram of the matching capacitors.
- 6. Load samples
 - a. Load samples on sample holder. Note that most of the thickness variability will be radial because of sample rotation, so expect thickness variations from the center to the edge of the sample holder. Verify that all screw holes are covered and that all screws are fully tightened down. You are welcome to use screws or Kapton tape to secure your samples.
 - b. Vent load lock
 - i. Unscrew and unlatch blue knob on load lock.
 - ii. Select "AUTO", then "LOAD LOCK AUTO VENT MODE SELECTED"
 - iii. Click "SELECT" on verification
 - iv. Click "START SELECTED CYCLE"
 - c. Load sample stage in load lock



- i. Set stage in the bayonet mount.
- ii. Orient screw toward you.
- iii. Raise sample stage all the way up if you plan to do load lock sputtering.
- d. Pump load lock
 - i. Close the door and gently tighten the handle.
 - ii. Select "AUTO" and then "LOAD LOCK FULL PUMP DOWN MODE SELECTED"
 - iii. Click "START SELECTED CYCLE"
 - iv. Wait for load lock convectron gauge to read "Off Scale". This happens a few minutes after the automatic process is complete.
- 7. Clean sample in load lock (optional)
 - a. Ensure the sample stage is all the way up.
 - b. Enter manual mode by selecting "MANUAL".
 - c. Close the "LL HIGH VAC VALVE" and open the "LL GATE VALVE".
 - d. Run MMF-LoadLock or other cleaning process.
- 8. Transfer sample
 - a. Ensure load lock convectron gauge reads "Off Scale".
 - b. Open "LL GATE VALVE".
 - c. Turn on lamp.
 - d. Make sure ruler on top of chamber (stage height ruler) is set to 85 mm.
 - e. Carefully and smoothly move the transfer arm all the way into the load lock.
 - f. Lower the sample stage onto the transfer arm fork. Do this slowly and carefully, while making small adjustments to the rotation and transfer arm position. If the fork starts to bend downward, stop and assess. Make sure the stage sits flat on the fork. When the sample stage is resting on the fork, raise the bellows so that the sample stage can be moved into the main chamber.
 - g. Carefully and smoothly move the transfer arm to the main chamber transfer position.
 - h. Use the motorized stage to lower the main chamber bayonet mount and lift the sample stage.
 - i. Fully retract the load arm.
 - j. In manual mode, close the "LL HIGH VAC VALVE" and "LL GATE VALVE".
 - k. Lower or raise the sample stage to the desired height for deposition.
- 9. Deposit
 - a. Open the appropriate database and select the desired process. **Do not edit anything but the process time in the MMF-Standard-Recipes database.**
 - b. Edit the process if necessary.



- c. Click "START PROCESS"
- d. Monitor the tool during ramp up and during the deposition.
 - i. Verify that the plasma strikes. If it does not by the time the supply reaches about 100 W, stop the process. See the troubleshooting section.
 - ii. After the plasma strikes, close the view port shutter slowly. If this shutter is opened or closed quickly, it can get stuck. Open it periodically to view that the process is proceeding as expected.
 - iii. Verify that the source shutter opens when process starts and that the stage is rotating.
 - iv. Verify that the reflected power decreases to <5 W and remains at that level during the deposition.
 - v. Verify that the sample shutter opens after the ramp and hold steps.
- 10. Unload sample
 - a. After the deposition, wait for the sample temperature to read <70 C on the "SAMPLE HEATING" reading next to the EMO. Below the angstrom engineering sign.
 - b. Raise the sample holder back to 85 mm.
 - c. Move the transfer arm back to the main chamber's loading position.
 - d. Set sample holder onto transfer arm's fork using the z-height controller and rotation knob.
 - e. Once the sample holder is loaded onto the transfer arm's fork, open the load lock gate valve and move the sample holder to the load lock's unloading position.
 - f. Unload the sample holder and fully retract the transfer arm.
 - g. Select "load-lock auto vent" and wait for the cycle to complete.
 - h. Once the load lock is completely vented, open the load lock's door and remove the sample holder.
- **11.** If finished depositing, close the load lock's door and tighten the blue knob. Select full pump down and let cycle complete.

Troubleshooting

- Chamber will not vent.
 - Ensure lab N2 is on and has enough pressure.
- Cryo temperature is between 14 and 18 K
 - Use the equipment but report the problem to the lab manager.
- Cryo temperature is >18 K
 - Do not use the tool and report the problem to staff.
- Process aborts with "Sigma has selected a wrong combination "FAULT"
 - Acknowledge and reset the fault.
 - Look for interlocks which may not be met for depositing.
 - Check recipe for accidentally changed or incorrect values.



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- Process aborts with "Gate Valve is Faulted"
 - In manual mode,
- Tool reads "System Disabled Log In On SUMS to Enable"
 - Log into SUMS and into the tool. If this does not work, contact staff.
- Sample shutter did not open during deposition
 - Check recipe
- Plasma did not strike
 - Pressure might be too low. Change source number down.
- This message appears when attempting load lock vent: cycle stop has been requested fault
 - Acknowledge error, go back to software home screen (might have to close previous window), acknowledge and reset fault. After doing this, if gate valve is still yellow, enter manual mode and open gate valve.